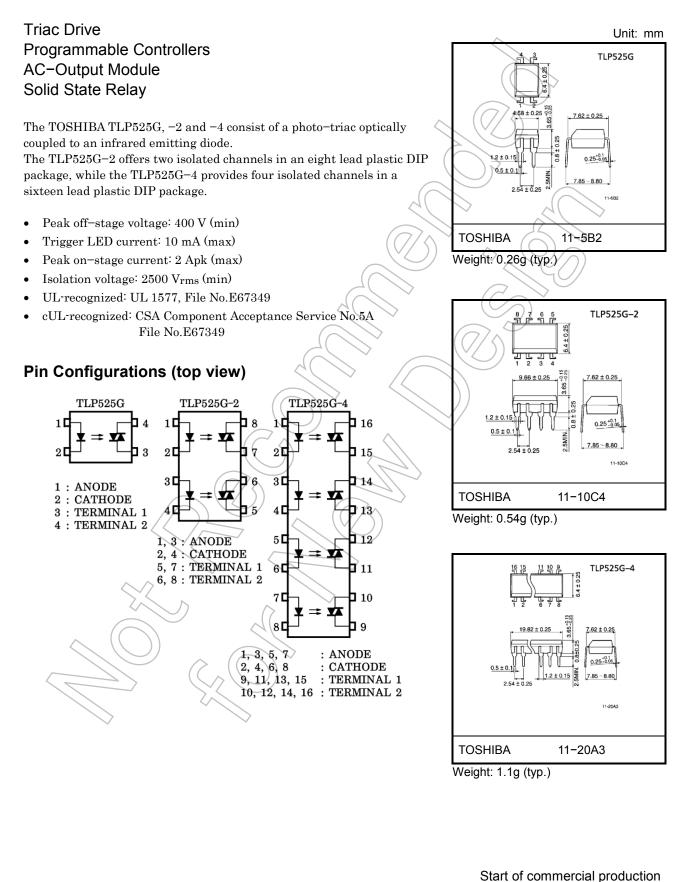
TOSHIBA Photocoupler IRED & Photo-Triac

TLP525G, TLP525G-2, TLP525G-4



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Absolute Maximum Ratings (Ta = 25°C)

Characteristics				Rat		
			Symbol	TLP525G	TLP525G–2 TLP525G–4	Unit
	Forward current		lF	50	50	mA
LED	Forward current derating		I _F / °C	-0.7 (Ta≥53°C) -0.5 (Ta≥25°C		mA / °C
	Pulse forward current		IFP	1 (100µs pu	А	
	Reverse voltage		VR	Ę	V	
	Input power dissipation		PD	50	60	mW
	Input power dissipation derating		∆P _D /°C	-0.69(Ta ≥ 53°C) -0.6(Ta ≥ 25°C)		mW/°C
	Junction temperature		Tj	12	°C	
	Off-state output terminal voltage		VDRM	40	V	
	On-state RMS current	Ta = 25°C	I	100	80	() A
		Ta = 70°C	I _{T (RMS)}	50	40	mA
	On–state current derating (Ta ≥ 25°C)		I _T / °C	-1.1	-0.9	mA / °C
Detector	Peak on state current		ITP	2 (100µs pu	A	
Det	Peak non-repetitive surge current (P _W = 10ms)		ITSM	1	A	
	Output power dissipation		Po	300	240	mW
	Output power dissipation derating (Ta ≥ 25°C)		ΔP _o /°C	-3.0	-3.0 -2.4	
	Junction temperature		Q.	415		°C
Storage temperature range		Tstg	-55 to 125		°C	
Operating temperature range		Topr	-40 to 100		°C	
Lead soldering temperature		T _{sol}	260 (10 s)		°C	
Isola	ation voltage	BVs	2500 (AC, 60 s, R.H. ≤ 60 %)		V _{rms}	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Device considered a two terminal device: LED side pins shorted together and detector side pins shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	VAC	_	_	120	Vac
Forward current	lF	15	20	25	mA
Peak on-state current	ITP	_	_	1	А
Operating temperature	Topr	-25		85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

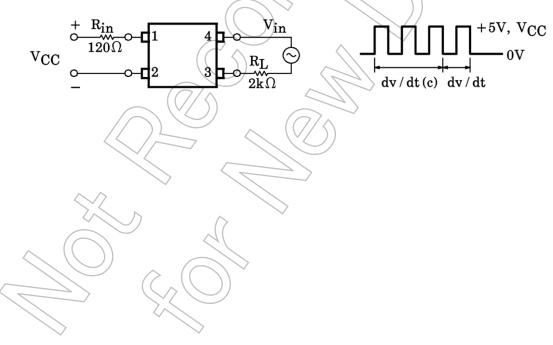
Individual Electrical Characteristics (Ta = 25°C)

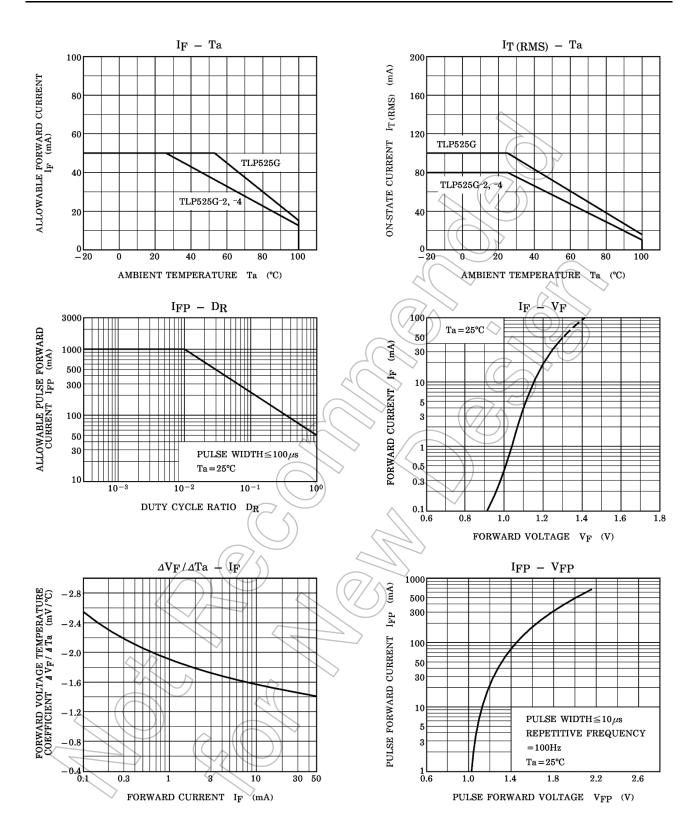
	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	Ст	VF = 0 V, f = 1 MHz	_<	30	_	pF
	Peak off-state current	IDRM	V _{DRM} = 400 V	- (10	100	nA
	Peak on-state voltage	V _{TM}	I _{TM} = 100 mA	_ \	×.7)	3.0	V
Detector	Holding current	Ŀμ	_	(7)	0.6		mA
	Critical rate of rise of off-state voltage	dv / dt	V _{in} = 120 V _{rms} , Ta = 85 °C (Figure 1)	200	500		V / μs
	Critical rate of rise of commutating voltage	dv / dt (c)	V _{in} = 30 V _{rms} , I _T = 15 mA (Figure 1)		0.2	- ()	V / μs

Coupled Electrical Characteristics (Ta = 25°C)

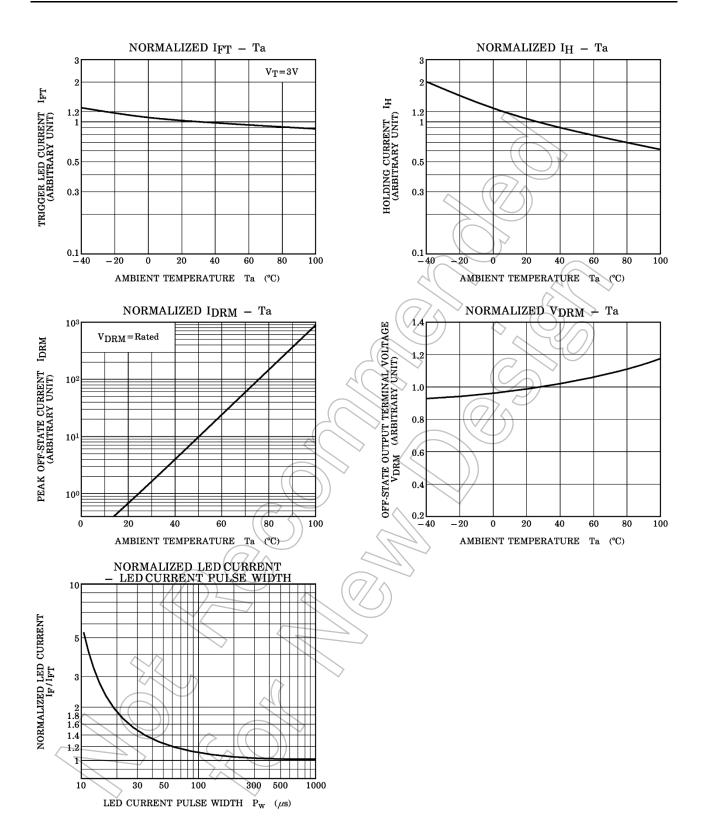
				$\langle \rangle$	
Characteristic	Symbol	Test Condition	Min. Typ.	Max.	Unit
Trigger LED current	IFT	V _T = 3 V	- 5	10	mA
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz	-(0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60 %	5×10 ¹⁰ 10 ¹⁴	-	Ω
Isolation voltage	BVS	AC, 60 s	2500 —	_	Vrms

Fig.1 dv / dt Test Circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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